| © Co                         | terial Compositi<br>pyright 2005. IPC, E<br>national and Pan-Am                                      | Bannockb           | urn, Illinois. A          | ll rights reserved utions. | under both                                     | This docum<br>level parts, t                                    | ent is a declaration    | ion of the s<br>encompasse          | ubstances<br>es all lowe | within the ma<br>r level materi | anufacture<br>als for wh        | er listed ite<br>nich the ma    | n. Note:<br>nufactur | if the item is an as<br>er has engineering | sembly with low responsibility. |
|------------------------------|--|--------------------|---------------------------|----------------------------|--|---|-------------------------|-------------------------------------|--------------------------|---------------------------------|---------------------------------|---------------------------------|----------------------|--|---------------------------------|
|                              | IPC Web Site for Information on IPC-1752 Standard Form Typ<br>http://www.ipc.org/IPC-175x Distribute |                    |                           |                            | *  | Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Mater |                         |                                     |                          |                                 | als and Mfg Information         |                                 |                      |  |                                 |
| Supplier Information         |  |                    |                           |                            |  |   |                         |                                     |                          |                                 |                                 |                                 |                      |  |                                 |
| Company name*                |  |                    | Company unique ID         |                            |  |   | Unique ID Authority     |                                     |                          |                                 |                                 | Response Date*                  |                      |  |                                 |
| nsemi                        |  |                    |                           |                            |  |   |                         |                                     |                          | 2024-05-04                      |                                 |                                 |                      |  |                                 |
| Contact Name Tit             |  |                    | Title - Contac            | Title - Contact            |  |   | Phone - Contact*        |                                     |                          |                                 |                                 | Email - Contact*                |                      |  |                                 |
| Product-Env-Stewards         |  |                    | Product Enviro Compliance |                            |  |   | NA                      |                                     |                          |                                 |                                 | Product-Env-Stewards@onsemi.com |                      |  |                                 |
| Authorized Representative*   |  |                    | Title - Representative    |                            |  |   | Phone - Representative* |                                     |                          |                                 | Email - Representative*         |                                 |                      |  |                                 |
| Product-Env-Stewards         |  |                    | Product Enviro Compliance |                            |  |   | NA                      |                                     |                          |                                 | Product-Env-Stewards@onsemi.com |                                 |                      |  |                                 |
| Requester Item N             | Requester Item Number Mfr Iten   |                    | n Number Mfr Item Name    |                            |  |   | Effective Date          | Date Version Manufacturing Site     |                          | g Site                          | W                               | eight*                          | UOM                  | Unit Type                                  |                                 |
|                              |  | DTA115TET1G PNP Di |                           | PNP Digital Tran           | NP Digital Transistor (BRT)                    |   | 2024-05-04              |                                     |                          |                                 |                                 | 2.                              | 51                   | mg   | Each                            |
| Ianufacturing Procee         | ess Information  |                    |                           |                            |  |   |                         |                                     |                          |                                 |                                 | <u>i</u>                        |                      |  |                                 |
| Terminal Plating             | Terminal Plating / Grid Array Material Terminal Base .   |                    | Alloy                     | J-STD-020 MS               | Peak Process Body Temperature Max Time at Peak |   |                         | Temperature Number of Reflow Cycles |                          |                                 |                                 |                                 |                      |  |                                 |
| Matte Tin (Sn) - annealed CU |  | U Alloy            | y 1                       |                            |  | <b>260</b> C  |                         | С                                   | 30 sec                   |                                 | second                          | seconds 3                       |                      |  |                                 |
| omments                      |  |                    |                           |                            |  |   |                         |                                     |                          |                                 |                                 |                                 |                      |  |                                 |
| vel 1 - maximum time at p    | oeak temperature d   | uring sol          | dering is 10-3            | 0 seconds                  |  |   |                         |                                     |                          |                                 |                                 |                                 |                      |  |                                 |
| or more information rega     | rding material com   | position <b>p</b>  | please refer to           | page 3                     |  |   |                         |                                     |                          |                                 |                                 |                                 |                      |  |                                 |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |  |
|--|--|--|---|---|---|--|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP). |  |   |   |   |  |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>y others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the   | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | ances per the definitio  | on above  | Supplier Acceptance                             | * Accepted  |  |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |  |  |  |  |  |  |  |
| Declaration Signature  |  |  |   |   |   |  |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |   |   |  |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

| sigma range of distribution unless | otherwise noted). |                 |          |                              | -          | _      |        | -               |
|------------------------------------|-------------------|-----------------|----------|------------------------------|------------|--------|--------|-----------------|
| Homogeneous Material               | Weight            | Unit of Measure | Level    | Substance                    | CAS        | Exempt | Weight | Unit of Measure |
| Die                                | 0.06              | mg              | Supplier | Silicon (Si)                 | 7440-21-3  |        | 0.06   | mg              |
| Lead Frame                         | 0.75              | mg              | В        | Nickel (Ni)                  | 7440-02-0  |        | 0.2843 | mg              |
|                                    |                   |                 | Supplier | Iron (Fe)                    | 7439-89-6  |        | 0.393  | mg              |
|                                    |                   |                 | Supplier | Copper (Cu)                  | 7440-50-8  |        | 0.0727 | mg              |
| Mold Compound-Black                | 1.57              | mg              | Supplier | Ortho Cresol Novolac Resin   | 29690-82-2 |        | 0.157  | mg              |
|                                    |                   |                 | Supplier | Carbon Black (C)             | 1333-86-4  |        | 0.0078 | mg              |
|                                    |                   |                 | Supplier | Aluminum Hydroxide (Al(OH)3) | 21645-51-2 |        | 0.2277 | mg              |
|                                    |                   |                 | Supplier | Fused Silica (SiO2)          | 60676-86-0 |        | 1.0205 | mg              |
|                                    |                   |                 | Supplier | Phenolic Resin (Novolac)     | 9003-35-4  |        | 0.157  | mg              |
| Plating                            | 0.12              | mg              | Supplier | Tin (Sn)                     | 7440-31-5  |        | 0.12   | mg              |
| Wire Bond - Cu                     | 0.01              | mg              | Supplier | Copper (Cu)                  | 7440-50-8  |        | 0.01   | mg              |